# IRFBC30

Vishay Siliconix



**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>a</sub> max. (nC)

Configuration

## **Power MOSFET**

S

N-Channel MOSFET

2.2

600

31

4.6

17

Single

 $V_{GS} = 10 V$ 

### FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBC30PbF			
Lead (Pb)-free and halogen-free	IRFBC30PbF-BE3			

PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V <sub>DS</sub>	600	- V		
Gate-source voltage			V <sub>GS</sub>	± 20			
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		3.6			
		T <sub>C</sub> = 100 °C	I <sub>D</sub>	2.3	А		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	14	7		
Linear derating factor				0.59	W/°C		
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	290	mJ		
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	3.6	3.6 A		
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ		
Maximum power dissipation	$T_{\rm C} = 2$	25 °C	PD	74	W		
Peak diode recovery dV/dt <sup>c</sup>			dV/dt 3.0		V/ns		
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300			
Mounting torque	6-32 or M3 screw			10	lbf ∙ in		
				1.1	N · m		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 41 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.6 A (see fig. 12)

c.  $I_{SD} \le 3.6$  A, dl/dt  $\le 60$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C

S21-0868-Rev. C, 16-Aug-2021

1



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# IRFBC30

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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62					
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	0.50 -			°C/W			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		1.7	1				
	•					•			
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherw	ise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		ONS	MIN.	TYP.	MAX.	UNIT	
Static	1	1				1	1		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0	V, I <sub>D</sub> = 25	0 μΑ	600	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I <sub>l</sub>	) = 1 mA	-	0.62	-	V/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_0$	<sub>3S</sub> , I <sub>D</sub> = 25	0 μΑ	2.0	-	4.0	V	
Gate-source leakage	I <sub>GSS</sub>		$_{3} = \pm 20 \text{ V}$		-	-	± 100	nA	
			00 V, V <sub>GS</sub> :		-	-	100		
Zero gate voltage drain current	Itage drain current $I_{DSS}$ $V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		Г <sub>Ј</sub> = 125 °С	-	-	500	μA		
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		= 2.2 A <sup>b</sup>	-	-	2.2	Ω	
Forward transconductance	9 <sub>fs</sub>		0 V, I <sub>D</sub> = 2	.2 A <sup>b</sup>	2.5	-	-	S	
Dynamic	1	,				1	1		
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$			-	660	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	86	-			
Reverse transfer capacitance	C <sub>rss</sub>			-	19	-			
Total gate charge	Qg				-	-	31	nC	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		$V_{DS} = 360 V$ ,	-	-	4.6		
Gate-drain charge	Q <sub>gd</sub>	see fig. 6 and 13 <sup>b</sup>			-	-	17		
Turn-on delay time	t <sub>d(on)</sub>				-	11	-		
Rise time	t <sub>r</sub>	$V_{DD}$ = 300 V, $I_D$ = 3.6 A , $R_g$ = 12 $\Omega,R_D$ = 82 $\Omega,$ see fig. 10 $^{\rm b}$			-	13	-	ns	
Turn-off delay time	t <sub>d(off)</sub>				-	35	-		
Fall time	t <sub>f</sub>				-	14	-		
Gate input resistance	Rg	f = 1 MHz, open drain			0.5	-	4.9	Ω	
Internal drain inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact			-	4.5	-	nH	
Internal source inductance	L <sub>S</sub>				-	7.5	-		
Drain-Source Body Diode Characterist	ics	•				•	•	•	
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.6	A		
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	14			
Body diode voltage	V <sub>SD</sub>	$T_{\rm J}$ = 25 °C, I <sub>S</sub> = 3.6 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.6	V		
Body diode reverse recovery time	t <sub>rr</sub>			-	370	810	ns		
Body diode reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 3.6 \text{ A}, dl/dt = 100 \text{ A}/\mu \text{s}^{\text{b}}$			-	2.0	4.2	μC	
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )							

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

2



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

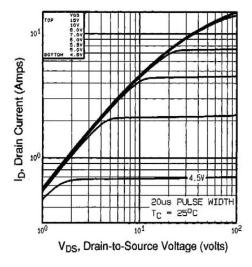


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

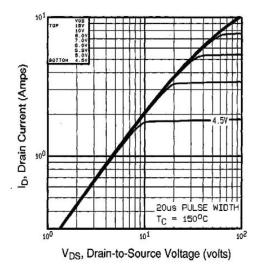


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

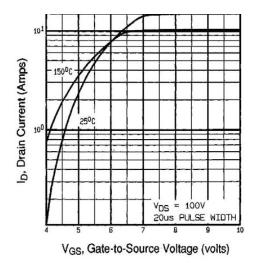


Fig. 3 - Typical Transfer Characteristics

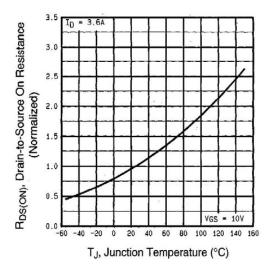


Fig. 4 - Normalized On-Resistance vs. Temperature

3



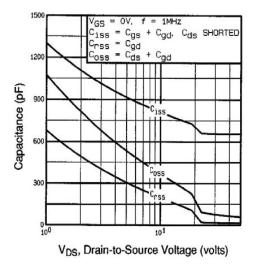
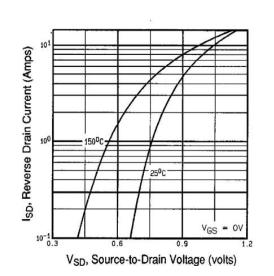


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





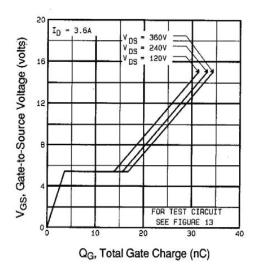


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

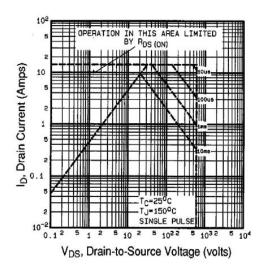


Fig. 8 - Maximum Safe Operating Area

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S21-0868-Rev. C, 16-Aug-2021



IRFBC30

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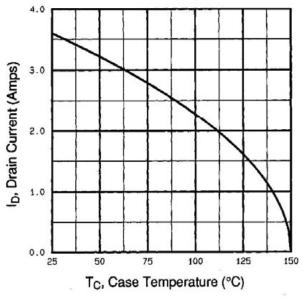


Fig. 9 - Maximum Drain Current vs. Case Temperature

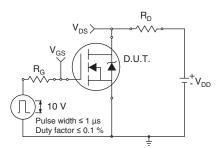


Fig. 10a - Switching Time Test Circuit

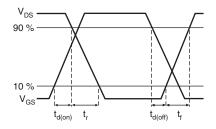


Fig. 10b - Switching Time Waveforms

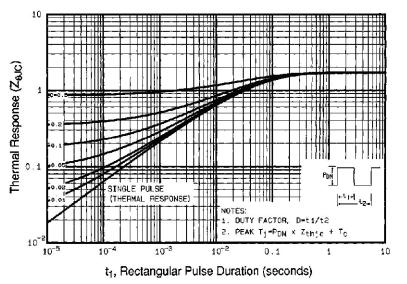


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

5



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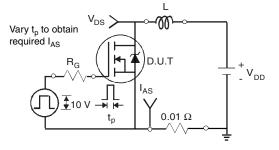


Fig. 12a - Unclamped Inductive Test Circuit

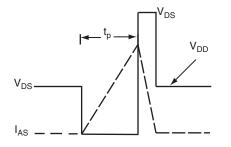
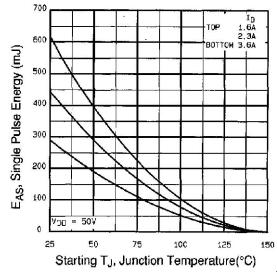


Fig. 12b - Unclamped Inductive Waveforms





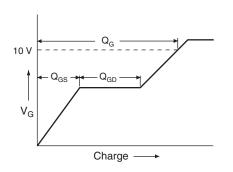
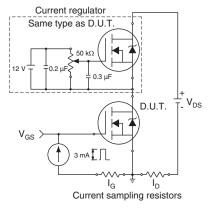


Fig. 13a - Basic Gate Charge Waveform





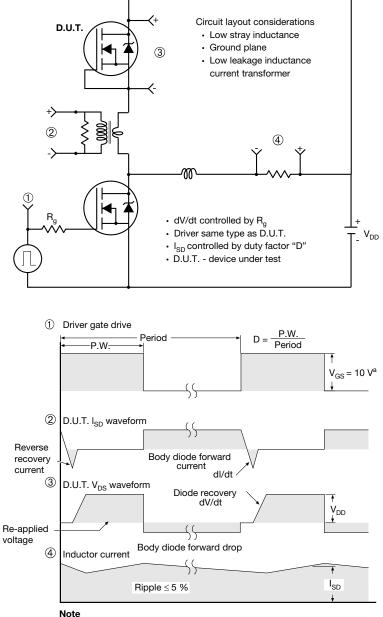




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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

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7

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1